505285622 01/18/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
CHU HAK KEE	01/16/2019

RECEIVING PARTY DATA

Name:	SOURCE PRO INDUSTRIES LTD.	
Street Address:	NO. 6 YIN FENG FIRST ROAD	
Internal Address:	YIN HU INDUSTRIAL PARK	
City:	XIEGANG TOWN DONGGUAN CITY	
State/Country:	CHINA	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16251341

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: THOMAS L. MOSES Address Line 1: P.O. BOX 14156

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ATTORNEY DOCKET NUMBER:	SPI-009	
NAME OF SUBMITTER:	THOMAS L MOSES	
SIGNATURE:	/Thomas L. Moses/	
DATE SIGNED:	01/18/2019	

Total Attachments: 2

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PATENT 505285622 REEL: 048056 FRAME: 0633

ASSIGNMENT

WHEREAS I have made certain invention(s) (hereinafter "Inventions") described in the following patent application:

Title: Temperature Control Power Cord, Power Cord with Power-Off Indication, and

Power Cord Connected with Load Power Source

Application No.: 16/251,341

Filing date: January 18, 2019

(hereinafter "Patent Application");

WHEREAS, Source Pro Industries Ltd., a corporation located at No. 6 Yin Feng First Road, Yin Hu Industrial Park in Xiegang Town, Dongguan City, Guangdong Province, China, is desirous of obtaining the entire right, title, and interest in, to, and under said Invention (hereinafter "Assignee");

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set over unto Assignee the entire right, title, and interest in, to, and under said Invention, throughout the world. These rights include, but are not limited to:

- 1. Right to apply for Letters Patent for the Invention, or any portion thereof, in the United States;
- 2. Right to apply for Letters Patent or the legal equivalent, including utility models, for the Invention, or any portion thereof, in any country or countries foreign to the United States;
- 3. All rights in, to, and under the above-referenced Patent Application, including, any national phase, continuations, divisionals, continuations-in-part, or any other applications based on or claiming priority to the Patent Application; and
- 4. All rights in, to, and under any Letters Patent, or legal equivalent, including all reissues, reexaminations or extensions thereof, that may be issued or granted on the applications described in paragraphs 1-3, above.

I HEREBY authorize and request the Commissioner of Patents of the United States and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent and/or legal equivalents, as requested, for said Invention or portion of said Invention to, and vest all rights of ownership in Assignee, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

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AND I HEREBY further covenant that I will communicate to Assignee any facts known to ME respecting said Invention, and testify in any legal proceeding, sign and execute lawful papers (including any application, assignment, and/or power of attorney documents), make all rightful oaths, and generally do everything possible to aid Assignee, to obtain and enforce proper patent protection for said Invention in all countries.

The rights granted to Assignee herein shall inure to the benefit of Assignee's successors in interest and assigns.

IN TESTIMONY, WHEREOF, I hereunto set our hands on the date and at the place set forth below.

Inventor

Signature:

Printed: Chu Kak Kee

Date: <u>Jan 16, 2019</u>